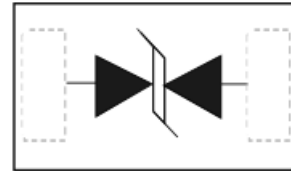


## Description

The LESD8LH5.0CT5G is designed to protect voltage sensitive components that require ultra-low capacitance from ESD and transient voltage events. Excellent clamping capability, low capacitance, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed and antenna line applications.



## Features

- Ultra Low Capacitance 3 pF
- Low Clamping Voltage
- Small Body Outline Dimensions:  
0.039" x 0.024" (1.00 mm x 0.60mm)
- Low Body Height: 0.020" (0.5 mm)
- Stand-off Voltage: 5 V
- Low Leakage
- Response Time is Typically < 1.0 ns
- IEC61000-4-2 Level 4 ESD Protection
- This is a Pb-Free Device

## Mechanical Characteristics

CASE: Void-free, transfer-molded, thermosetting plastic Epoxy Meets UL 94 V-0  
LEAD FINISH: 100% Matte Sn (Tin)  
QUALIFIED MAX REFLOW TEMPERATURE: 260°C  
Device Meets MSL 1 Requirements

## MAXIMUM RATINGS

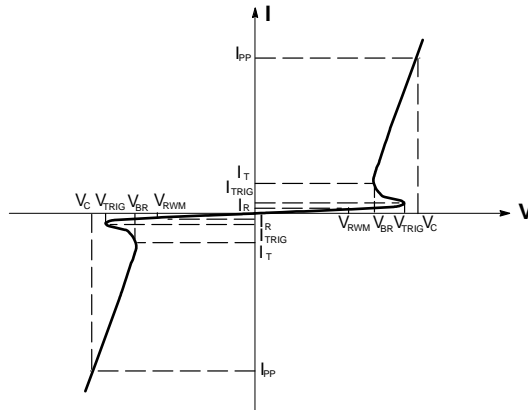
Rating	Symbol	Value	Unit
IEC61000-4-2 (ESD) Contact Air		±10 ±15	kV
Total Power Dissipation on FR-5 Board (Note 1) @ T <sub>A</sub> = 25 °C	P <sub>D</sub>	150	mW
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Junction Temperature Range	T <sub>J</sub>	-55 to +125	°C
Lead Solder Temperature – Maximum (10 Second Duration)	T <sub>L</sub>	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0 x 0.75 x 0.62 in.

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Reverse standoff voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$V_{TRIG}$	Reverse trigger voltage
$I_{TRIG}$	Reverse trigger current

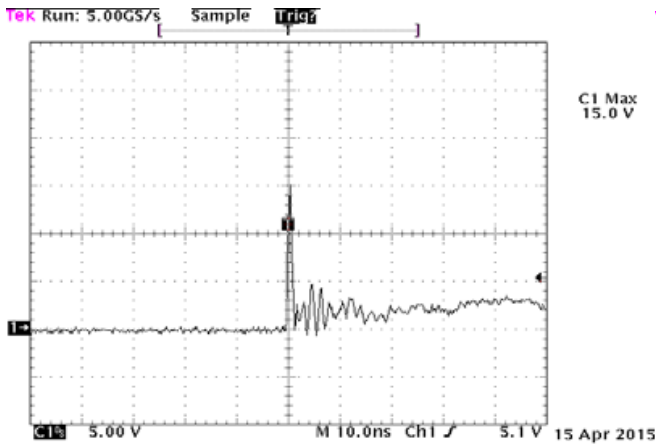


Bi-Directional TVS

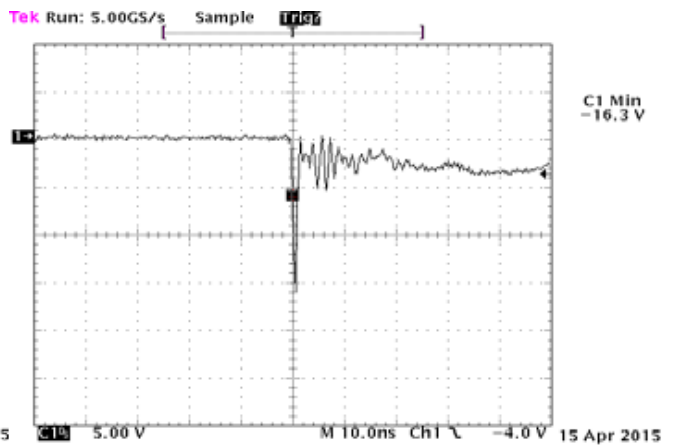
**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Device	$V_{RWM}$ (V)	$I_R$ ( $\mu\text{A}$ ) @ $V_{RWM}$	$V_{BR}$ (V) @ $I_T = 1\text{mA}$ (Note 2)	C (pF)		$V_C$ (V) @ $I_{PP} = 3.5\text{A}$ (Note 3)	$I_{PP}$ (A) $t_p=8/20\mu\text{s}$	$P_{PP}$ (W)	$V_C$
	Max	Max	Min	Typ	Max	Max	Max	Max	Per IEC61000-4-2 (Note4)
LESD8LH5.0CT5G	5.0	1	5.5	2.7	3.5	11.5	3.5	40	Figures 1 and 2 See Below

2.  $V_{BR}$  is measured with a pulse test current  $I_T$  at an ambient temperature of  $25^\circ\text{C}$ .
3. Surge current waveform per Figure 4.
4. For test procedure see Figures 3.



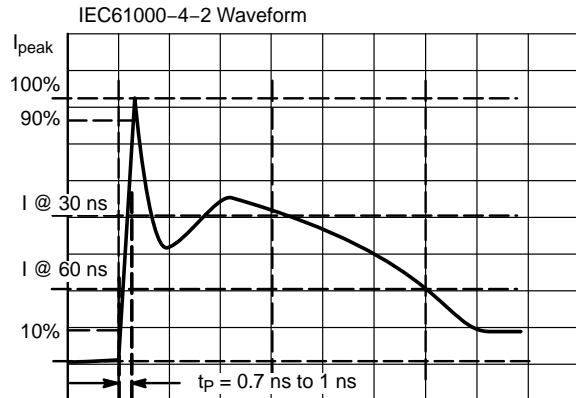
**Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV Contact per IEC61000-4-2**



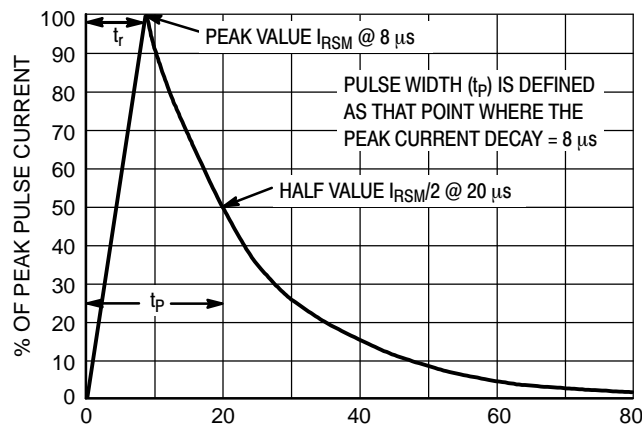
**Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2**

**IEC 61000-4-2 Spec.**

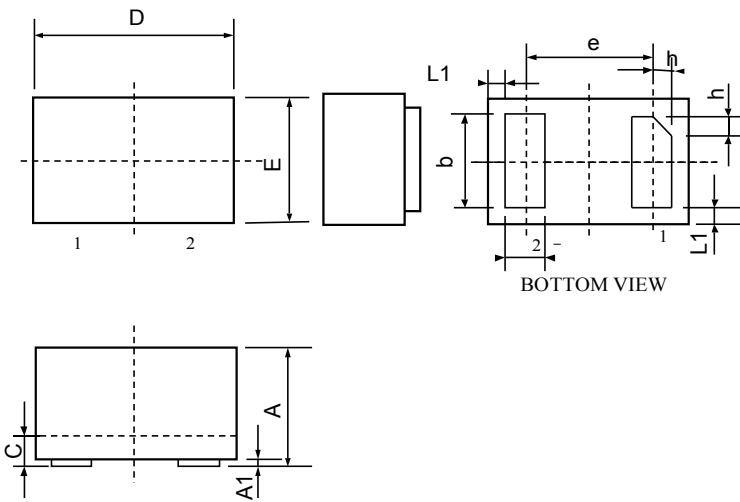
Level	Test Voltage (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8



**Figure 3. IEC61000-4-2 Spec**

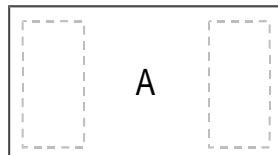


**Outline Drawing – SOD-882**



SYMB	MILIMETER		
	MIN	NOM	MAX
OL			
A	0.45	0.50	0.55
A1	0	0.02	0.05
b	0.45	0.50	0.55
C	0.12	0.15	0.18
D	0.95	1.00	1.05
e	0.65BSC		
E	0.55	0.60	0.65
L	0.20	0.25	0.30
L1	0.05REF		
h	0.07	0.12	0.17

**Marking**



**Ordering information**

Order code	Package	Baseq	Deliverymode
LESD8LH5.0CT5G	SOD-882	10000	Tape and reel